



## Paladin® Cabled Backplane

# EXTENDING THE REACH OF PASSIVE COPPER IN BACKPLANE, MIDPLANE AND OVERPASS CABLE APPLICATIONS

Cable Backplane Systems is part of Amphenol ICC's Highspeed Backplane Product business, dedicated to developing and manufacturing cabled backplane solutions for next generation system architectures. Our customers are leading providers of datacenter switches and routers, enterprise servers and high performance computers. Products include IO style cables, internal OverPass cables, and full mesh harness structures for both backplane and midplane applications.

- Extends the reach of passive copper for next generation real world system designs; complementary with direct orthogonal designs, intermatable with existing board mount connector designs
- Lowers overall system costs by reducing or eliminating the need for expensive active devices like retimers and high performance board materials
- Market leading backplane connector families Paladin®
- Proven reliability of passive twin ax copper coupled with advanced wire attachment and 100% high speed test coverage provides peace of mind
- Turn key support provides mechanical application design services and signal integrity consultation from wire level through system level



#### **FEATURES**

- Fully passive copper cable assembly
- Same mechanical benefits as backplane connectors
- Low loss twin ax cable
- Linear transmission beyond 40 GHz
- Flexible pin out
- 32 28 AWG wire gauges
- 100% high speed test coverage
- Mate compatible with press fit headers, right angle and orthogonal configurations

#### **BENEFITS**

- Low cost reliable signal transmission
- High pin counts, blind mate & high density
- Overcomes limitation of PCB materials
- Enables 56G NRZ and 110G PAM4 performance
- Allows for full mesh designs with cable harnesses
- Optimization of transmission and cable routing
- Assurance of functional performance
- Line cards / switch cards can be shared between systems allowing for a scalable platform

### **▶** Paladin® Cabled Backplane

## **TECHNICAL INFORMATION**

#### **MATERIAL**

- Contacts: High performance Copper Alloy
- Plating(s): Performance-based plating at separable interface (Telcordia GR-1217-CORE)
- Housings: High Performance Thermoplastic, UL94-V0
- Wire: Silver and tin plated copper, polyolefin, aluminized polyester foils

#### **ELECTRICAL PERFORMANCE**

- Differential Impedances: 95  $\Omega$
- Supporting all major protocols: IEEE, InfiniBand, OmniPath, UPI, PCIe, SAS

#### **MECHANICAL PERFORMANCE**

- Mating wipe: 1.5mm or 2.25mm
- Housing Capture: min 1mm X and Y
- Durability: 250 mating cycles
- Mate and unmate forces equal to press fit connectors

#### APPROVALS AND CERTIFICATIONS

- Telcordia GR-1217 CORE Central Office
- UL94 V-0
- Twin AX UL HB and VW1

#### **PACKAGING**

Product specific

#### **ENVIRONMENTAL**

Operating Temperature Range: -40°C to 85°C connector system

#### **SPECIFICATIONS**

■ TB-2324 Paladin® Product Specification

#### **TARGET MARKETS/APPLICATIONS**



Switches Routers Access Hubs Wireless Infrastructure



Servers Datacenter External Storage System Supercomputers

## **PART NUMBERS**

## **DESCRIPTION** PART NUMBER

4X8 Paladin Cable, 30 AWG, 40 GHz	HS30720061
4X8 Paladin Cable, 28 AWG, 40 GHz	HS30753261
4X8 Paladin Cable, 30 AWG, 25 GHz	HS30780081